

Product Change Notification

[Home](#)

The information below reflects a change that is being implemented.

Notice Date: 05/09/2003
Product Category: 93xxx
Notification Subject: Change #345-2 - 93xxx family to 150K
Notification Body:

Projected Ship Date of Revised Device:
June 6, 2003

Description of Change:

The serial EEPROMs listed below will be moved from the current 77K (1.2 micron) fabrication process to the new 150K (0.5 micron) process. In order to continue receiving devices from the 77K process, the Revised 77K Part numbers listed below must be used. If an order is received using the current part numbers, Microchip will ship either the new device from the 150K process or the current device from the 77K process until this inventory is depleted. The devices affected include all voltages, temperatures, and packages of the following part numbers.

Current Part Number Revised 77K Part Number

93C56A-x/xx 93C56A-x/xxRVA
93C56B-x/xx 93C56B-x/xxRVA
93LC56A-x/xx 93LC56A-x/xxRVA
93LC56B-x/xx 93LC56B-x/xxRVA
93C66A-x/xx 93C66A-x/xxRVA
93C66B-x/xx 93C66B-x/xxRVA
93LC66A-x/xx 93LC66A-x/xxRVA
93LC66B-x/xx 93LC66B-x/xxRVA

Impacts to Data Sheet:

Changes consist of minor edits and clarifications to AC and DC characteristics and the addition of new packages. Note that current data sheets DS21206C, DS21208C, DS21207C and DS21209C will be obsoleted and replaced by DS21794A and DS21795A.

Reason for Change:

To add the MSOP , TSSOP and SOT-23 packages to the product line.

Markings to Distinguish Revised From Unrevised Devices: (e.g.: Date Code, Device Marking, Ship Container Marking):
Traceability codes.

Additional Comments: The revised part numbers listed above (with the RVA suffix) will give customers the option of ordering product from the older process without interruption.

Close

